

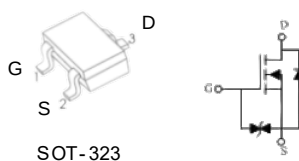
FEATURE

High-Side Switching
Low On-Resistance
Low Threshold
Fast Switching Speed

APPLICATION

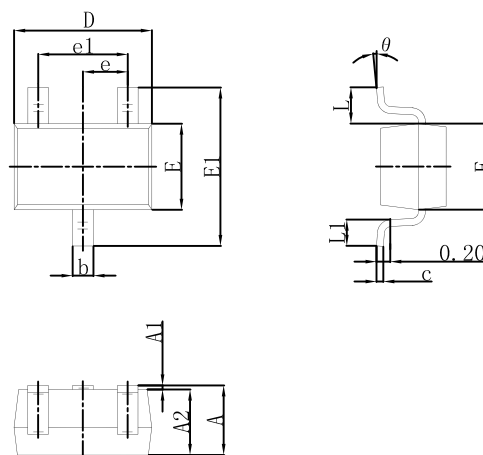
Drivers: Relays, Solenoids,
Lamps, Hammers, Displays, Memories
Battery Operated Systems
Power Supply Converter Circuits
Load/Power Switching Cell Phones, Pagers

MARKING : 34K



$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
20V	380 mΩ@4.5V	0.75A
	450 mΩ@2.5V	
	800 mΩ@1.8V	

SOT-323



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source voltage	V_{DSS}	20	V
Typical Gate-Source Voltage	V_{GS}	±12	
Drain Current-Continuous	I_D	0.75	A
Drain Current -Pulsed(note1)	I_{DM}	3	
Power Dissipation (note 2)	P_D	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	625	$^{\circ}\text{C/W}$
Storage Temperature	T_j	150	$^{\circ}\text{C}$
Junction Temperature	T_{stg}	-55 ~ +150	

3134K

$T_a=25^{\circ}\text{C}$ unless otherwise specified

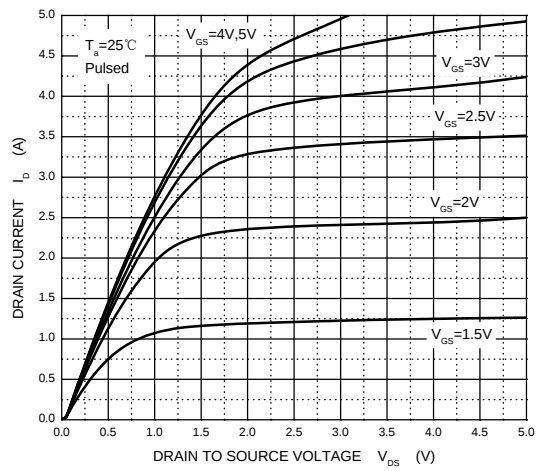
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
On/Off States						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	20			V
Gate-Threshold Voltage(note 3)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.35	0.54	1.1	
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±10V			±20	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	μA
Drain-Source On-State Resistance(note 3)	R _{DS(on)}	V _{GS} =4.5V, I _D =650mA		180	380	mΩ
		V _{GS} =2.5V, I _D =550mA		220	450	
		V _{GS} =1.8V, I _D =450mA		300	800	
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =800mA	1			S
Dynamic Characteristics(note 4)						
Input Capacitance	C _{iss}	V _{DS} =16V,V _{GS} =0V,f =1MHz		79	120	pF
Output Capacitance	C _{oss}			13	20	
Reverse Transfer Capacitance	C _{rss}			9	15	
Switching Times (note 4)						
Turn-On Delay Time	t _{d(on)}	V _{DD} =10V,I _D =500mA, V _{GS} =4.5V,R _G =10Ω		6.7		ns
Rise Time	t _r			4.8		
Turn-Off Delay Time	t _{d(off)}			17.3		
Fall Time	t _f			7.4		
Drain-Source Diode Characteristics						
Drain-Source Diode Forward Voltage (note 3)	V _{SD}	I _S =0.15A, V _{GS} = 0V			1.2	V

Notes:

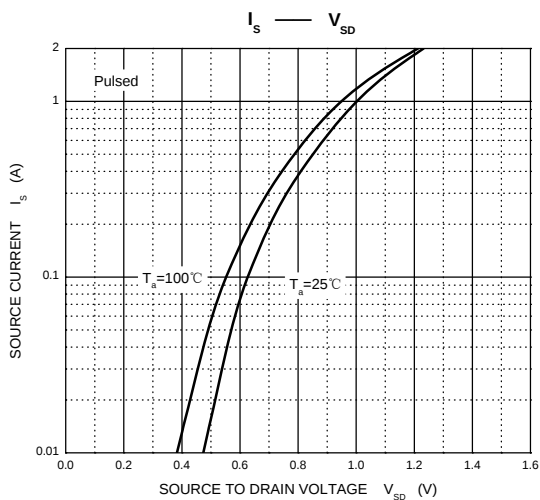
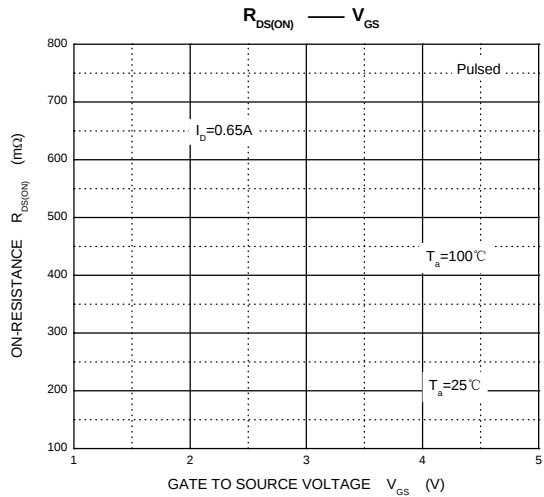
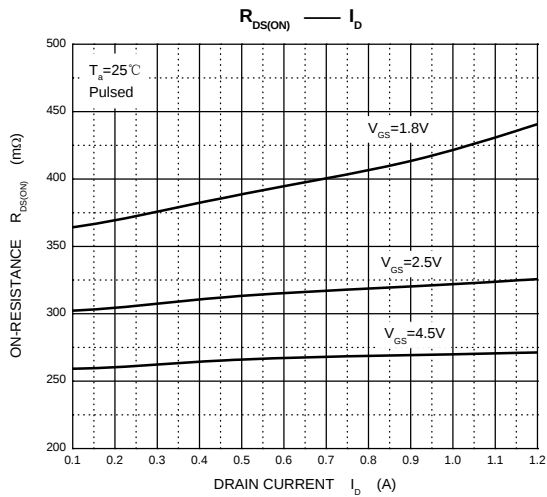
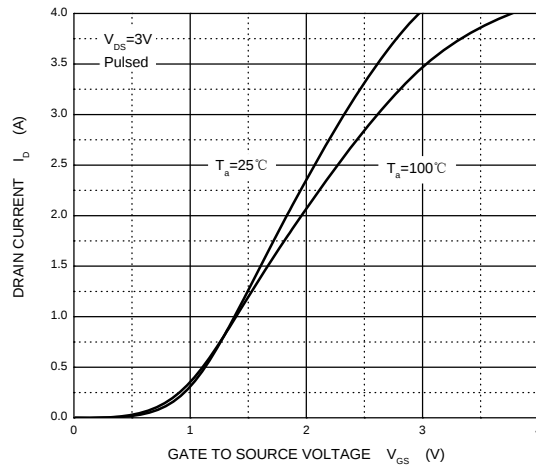
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at $T_a=25^{\circ}\text{C}$.
3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 0.5\%$.
4. These parameters have no way to verify.

RATING AND CHARACTERISTIC CURVES (3134K)

Output Characteristics



Transfer Characteristics



Threshold Voltage

